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## STD15P6F6AG

# Automotive-grade P-channel -60 V, 0.13 Ω typ., -10 A STripFET™ F6 Power MOSFET in a DPAK package

Datasheet - production data

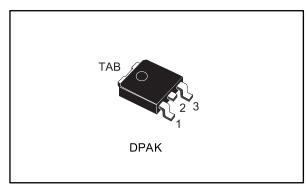
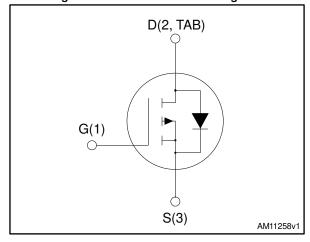


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max.	Ι <sub>D</sub>
STD15P6F6AG	-60 V	0.16 Ω	-10 A

- Designed for automotive applications and AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

## **Applications**

Switching applications

## **Description**

This device is a P-channel Power MOSFET developed using the STripFET<sup>TM</sup> F6 technology, with a new trench gate structure. The resulting Power MOSFET exhibits very low  $R_{DS(on)}$  in all packages.

Table 1: Device summary

Order code	Marking	Package	Packaging
STD15P6F6AG	15P6F6	DPAK	Tape and Reel

Contents STD15P6F6AG

# Contents

1	Electrical ratings		
2	Electric	eal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	DPAK package information	9
	4.2	Packing information	12
5	Revisio	n history	14

STD15P6F6AG Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	-60	V
$V_{GS}$	Gate-source voltage	± 20	V
$I_{D}^{(1)}$	Drain current (continuous) at T <sub>C</sub> = 25 °C	-10	Α
$I_D$	Drain current (continuous) at T <sub>C</sub> = 100 °C	-7.2	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	-40	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	35	W
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J=25~^{\circ}C,~I_D=-3~A,~V_{DD}=-40~V)$	80	mJ
$V_{DG}$	Drain-gate voltage	-20	V
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
Tj	Maximum junction temperature	175	°C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	4.29	°C/W
R <sub>thj-pcb</sub>	Thermal resistance junction-pcb max <sup>(1)</sup>	50	°C/W

### Notes:

<sup>&</sup>lt;sup>(1)</sup>Limited by package

 $<sup>\</sup>ensuremath{^{(2)}}\mbox{Pulse}$  width limited by safe operating area.

<sup>(1)</sup>When mounted on 1 inch<sup>2</sup> FR-4, 2 Oz copper board

Electrical characteristics STD15P6F6AG

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60			>
	Zoro goto voltago Droin	$V_{GS} = 0 \text{ V}, V_{DS} = -60 \text{ V}$			-1	μΑ
I <sub>DSS</sub>	Zero gate voltage Drain current	$V_{GS} = 0 \text{ V}, V_{DS} = -60 \text{ V},$ $T_{C} = 125 \text{ °C}$			-10	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-2		-4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5 A		0.13	0.16	Ω

**Table 5: Dynamic** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	340	1	pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = -48 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	40	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	20	1	pF
$Q_g$	Total gate charge		-	6.4	-	nC
$Q_{gs}$	Gate-source charge	V <sub>DD</sub> = -30 V, I <sub>D</sub> = -10 A, V <sub>GS</sub> = -10 V (see <i>Figure 14: "Gate charge test</i> <i>circuit"</i> )	-	1.7		nC
$Q_{gd}$	Gate-drain charge	,	-	1.7	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	64	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = -48 \text{ V}, I_{D} = -5 \text{ A R}_{G} = 4.7 \Omega,$	-	5.3	-	ns
t <sub>d(off)</sub>	Turn-off-delay time	V <sub>GS</sub> = -10 V (see Figure 13: "Switching times test circuit for resistive load")	ı	14	1	ns
t <sub>f</sub>	Fall time		-	3.7	-	ns

Table 7: Source drain diode

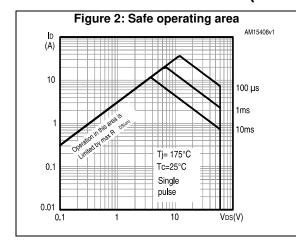
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		-10	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		-40	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = -5 \text{ A}$	-		-1.1	٧
t <sub>rr</sub>	Reverse recovery time		-	20		ns
Q <sub>rr</sub>	Reverse recovery charge	I <sub>SD</sub> = -10 A, di/dt = 100 A/μs, V <sub>DD</sub> = -48 V, (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	17.8		nC
I <sub>RRM</sub>	Reverse recovery current	, and the same state of the sa	-	-1.8		Α

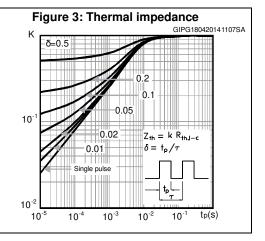
#### Notes:

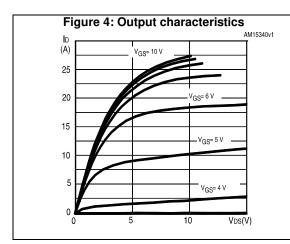
 $<sup>^{(1)}</sup>$ Pulse width limited by safe operating area.

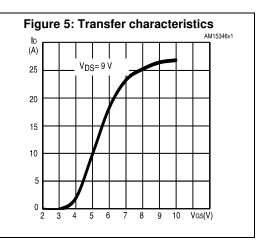
 $<sup>^{(2)}\</sup>text{Pulse test: pulse duration} = 300~\mu\text{s}, \, \text{duty cycle } 1.5\%$ 

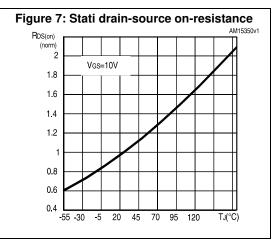
# 2.2 Electrical characteristics (curves)











STD15P6F6AG Electrical characteristics

Figure 8: Capacitance variations

AM15342v1

AM15342v1

Ciss

Coss

Crss

O 10 20 30 40 50 VDs(V)

Figure 9: Normalized V(BR)DSS vs temperature

V(BR)DSS (norm)

1.15

1.10

1.05

0.95

0.90
-55 -30 -5 20 45 70 95 120 TJ(°C)

Figure 10: Normalized gate threshold voltage vs temperature

VGS(th)
(norm)

1.10

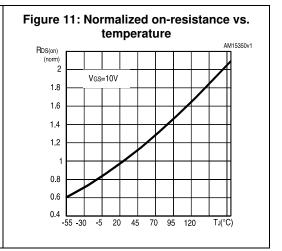
0.90

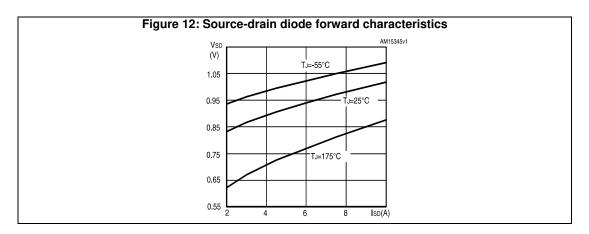
0.80

0.70

0.60

-55 -30 -5 20 45 70 95 120 TJ(°C)







For the P-channel Power MOSFET, current and voltage polarities are reversed.

Test circuits STD15P6F6AG

## 3 Test circuits

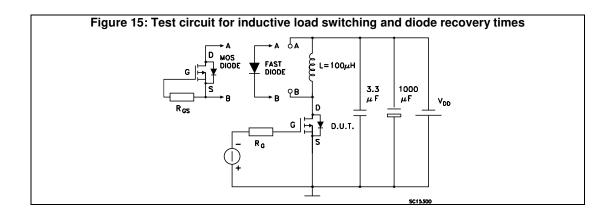
Figure 13: Switching times test circuit for resistive load

Figure 14: Gate charge test circuit

Figure 14: Gate charge test circuit

Output

Discrepance of the control of



STD15P6F6AG Package information

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

## 4.1 DPAK package information

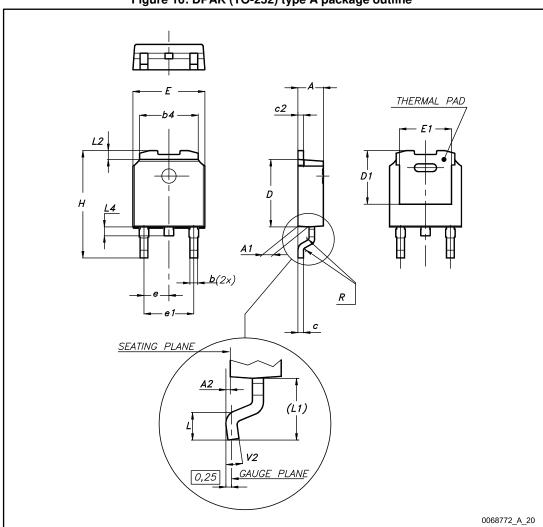


Figure 16: DPAK (TO-252) type A package outline

Table 8: DPAK (TO-252) type A mechanical data

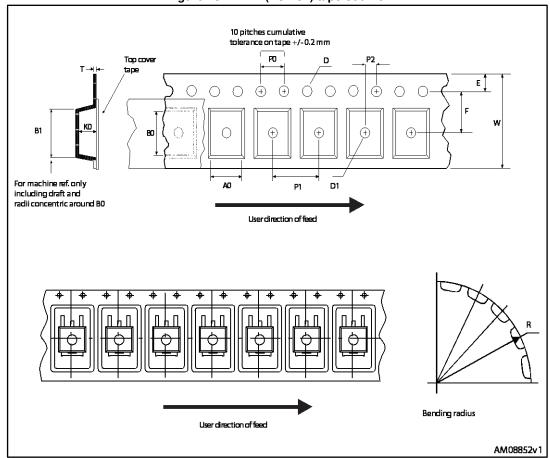
Table 6. DFAR (10-232) type A mechanical data				
Dim.	mm			
Dilli.	Min.	Тур.	Max.	
A	2.20		2.40	
A1	0.90		1.10	
A2	0.03		0.23	
b	0.64		0.90	
b4	5.20		5.40	
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
D1	4.95	5.10	5.25	
E	6.40		6.60	
E1	4.60	4.70	4.80	
е	2.16	2.28	2.40	
e1	4.40		4.60	
Н	9.35		10.10	
L	1.00		1.50	
(L1)	2.60	2.80	3.00	
L2	0.65	0.80	0.95	
L4	0.60		1.00	
R		0.20		
V2	0°		8°	

STD15P6F6AG Package information

Figure 17: DPAK (TO-252) recommended footprint (dimensions are in mm)

# 4.2 Packing information

Figure 18: DPAK (TO-252) tape outline



A 40mm min. access hole at slot location

Tape slot in core for tape start 2.5mm min.width

AM06038v1

Figure 19: DPAK (TO-252) reel outline

Table 9: DPAK (TO-252) tape and reel mechanical data

Таре				Reel	
Dim	m	ım	Dim	r	nm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	Α		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	e qty.	2500
P1	7.9	8.1	Bul	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

Revision history STD15P6F6AG

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
20-Oct-2015	1	First release.

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